

September 5, 2025

Village of Orland Park 14700 Ravinia Avenue Orland Park, Illinois 60462

Attention: Khurshid Hoda

Re: Estates at Ravinia Meadows, Orland Park Bond in Lieu of Letter of Credit Request

Mr. Hoda

Per your request, I am requesting from the Village to accept a Bond in Lieu of a Letter of Credit. This request is due to the timing of our anticipated development of the project, we can issue a bond in much less time than the Letter of Credit. Pulte Home Group has never had a bond, or a letter of credit drawn upon. Also if the City provides Pulte Home Company, LLC the format they would like the bond to be in, we would be able to issue it in that exact format, unlike an LOC which is negotiated between the bank and the City.

I, Ty Morris, am the owner's representative authorized to make this request.

Thank you in advance for your consideration.

Sincerely,

Ty Morris

Ty Morris

Vice President of Land Development